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**Harper, Jr. et al.**

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(54) **ELECTRICAL CONNECTOR**

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See application file for complete search history.

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(57)

**CLAIM**

The ornamental design for an electrical connector, as shown and described.

**DESCRIPTION**

This is related by subject matter to U.S. patent application Ser. No. 29/426,921 filed Jul. 11, 2012.

FIG. 1 is a top, left, front perspective view of an electrical connector showing our new design;

FIG. 2 is a larger view of area 2 as illustrated in FIG. 1;

FIG. 3 is a bottom, right, front perspective view of our new electrical connector thereof;

FIG. 4 is a larger view of area 4 as illustrated in FIG. 3;

FIG. 5 is a bottom, right, rear perspective view of our new electrical connector thereof;

FIG. 6 is a larger view of area 6 as illustrated in FIG. 5;

FIG. 7 is a bottom, left, front perspective view of our new electrical connector thereof;

FIG. 8 is a larger view of area 8 as illustrated in FIG. 7;

FIG. 9 is a top, left, rear perspective view of our new electrical connector thereof;

FIG. 10 is a larger view of area 10 as illustrated in FIG. 9;

FIG. 11 is a left side elevation view of our new electrical connector thereof;

FIG. 12 is a right side elevation view thereof;

FIG. 13 is a front elevation view thereof;

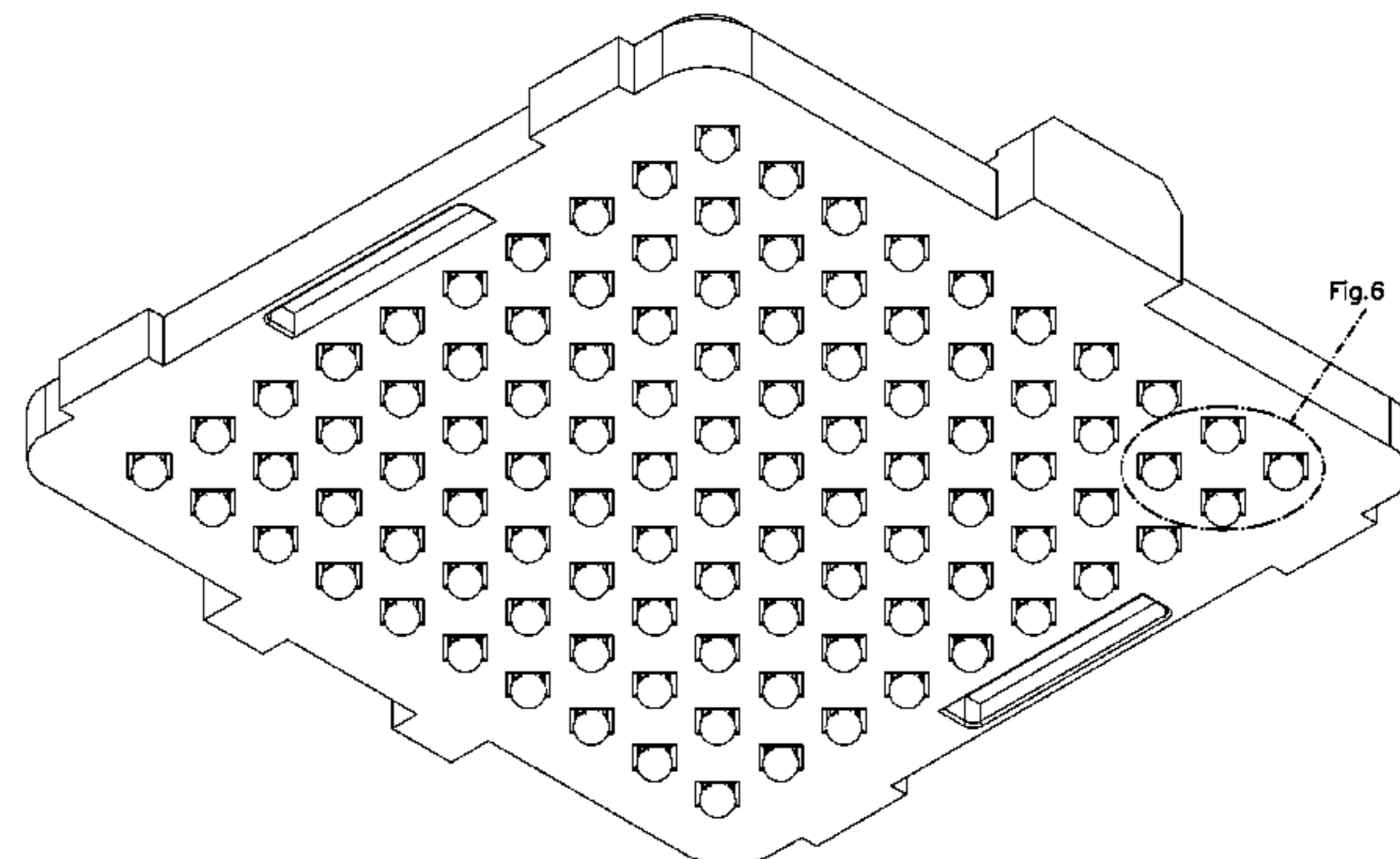
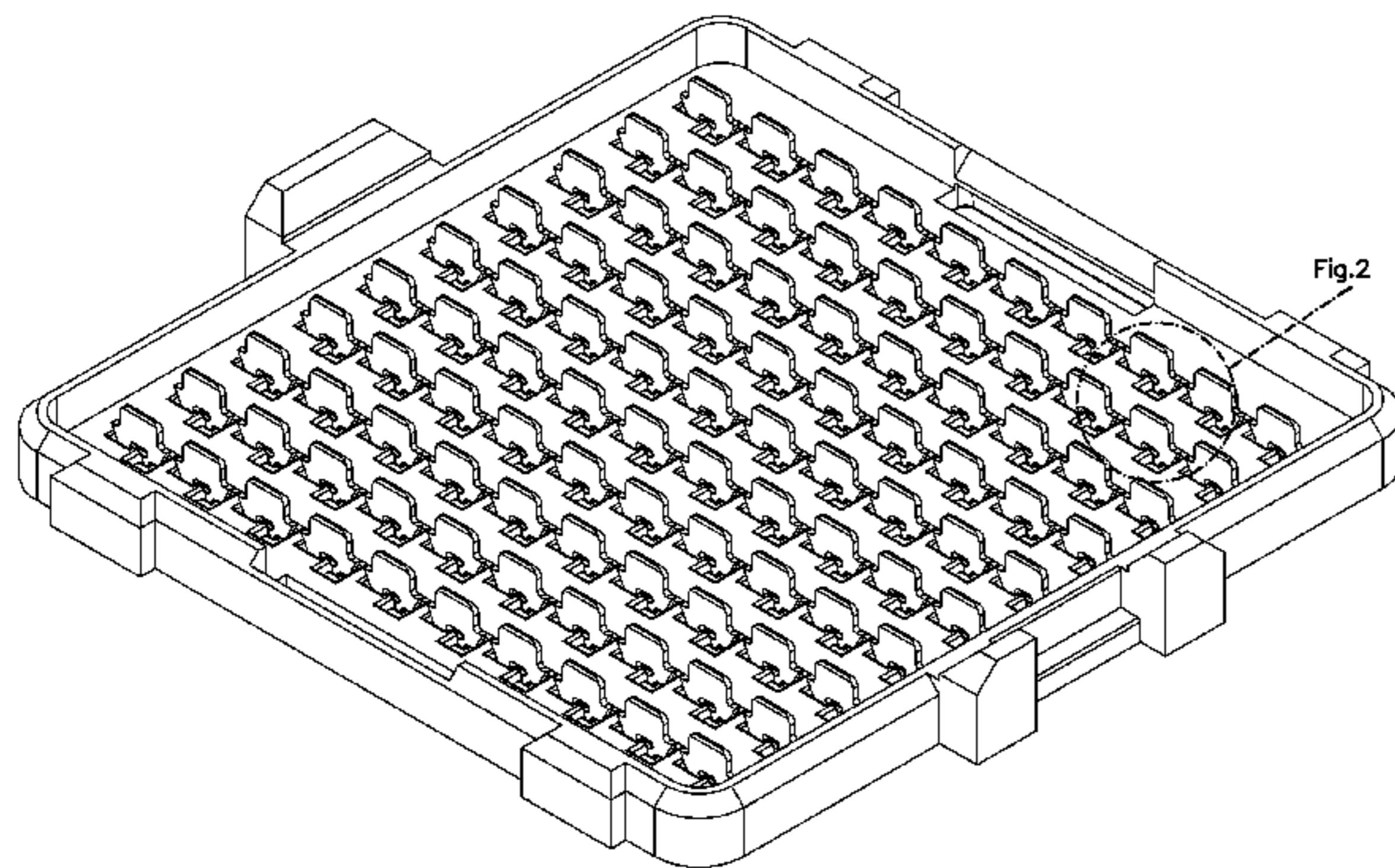
FIG. 14 is a rear elevation view thereof;

FIG. 15 is a bottom plan view thereof; and,

FIG. 16 is a top plan view thereof.

In a preferred embodiment, the nature of this product is an electrical component that can take the form of an electrical connector, and a connector housing therefor.

**1 Claim, 12 Drawing Sheets**





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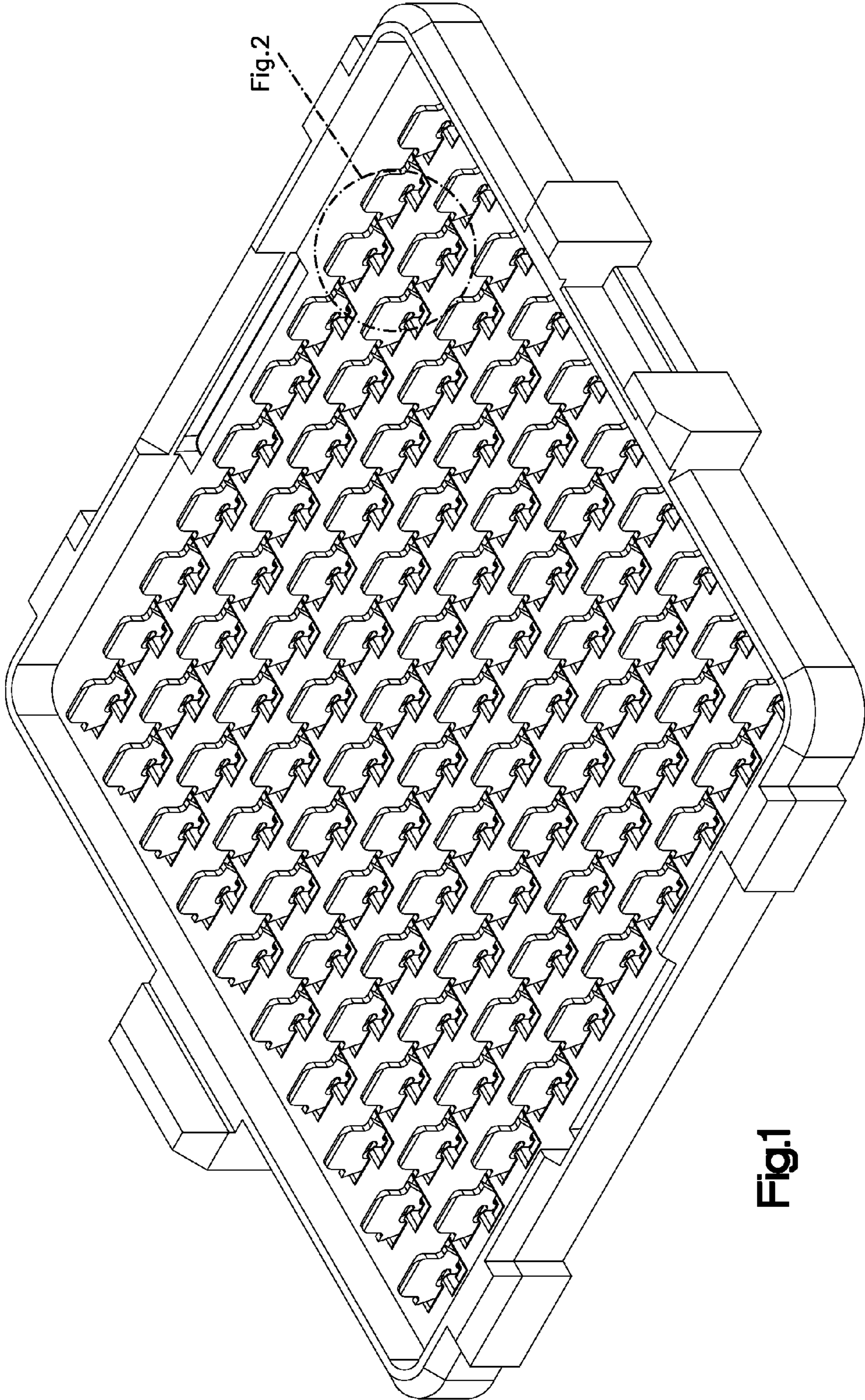
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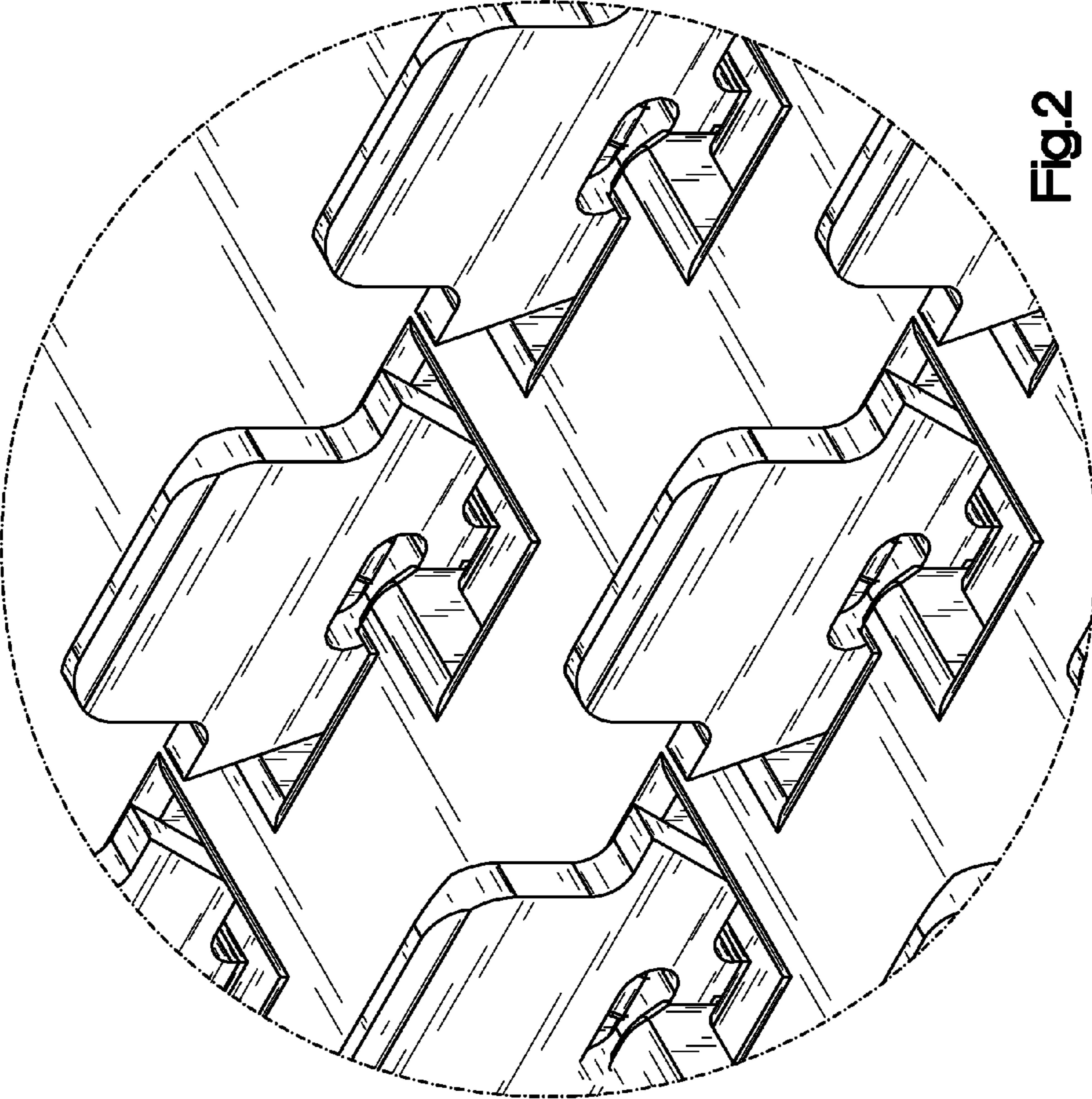


Fig.2



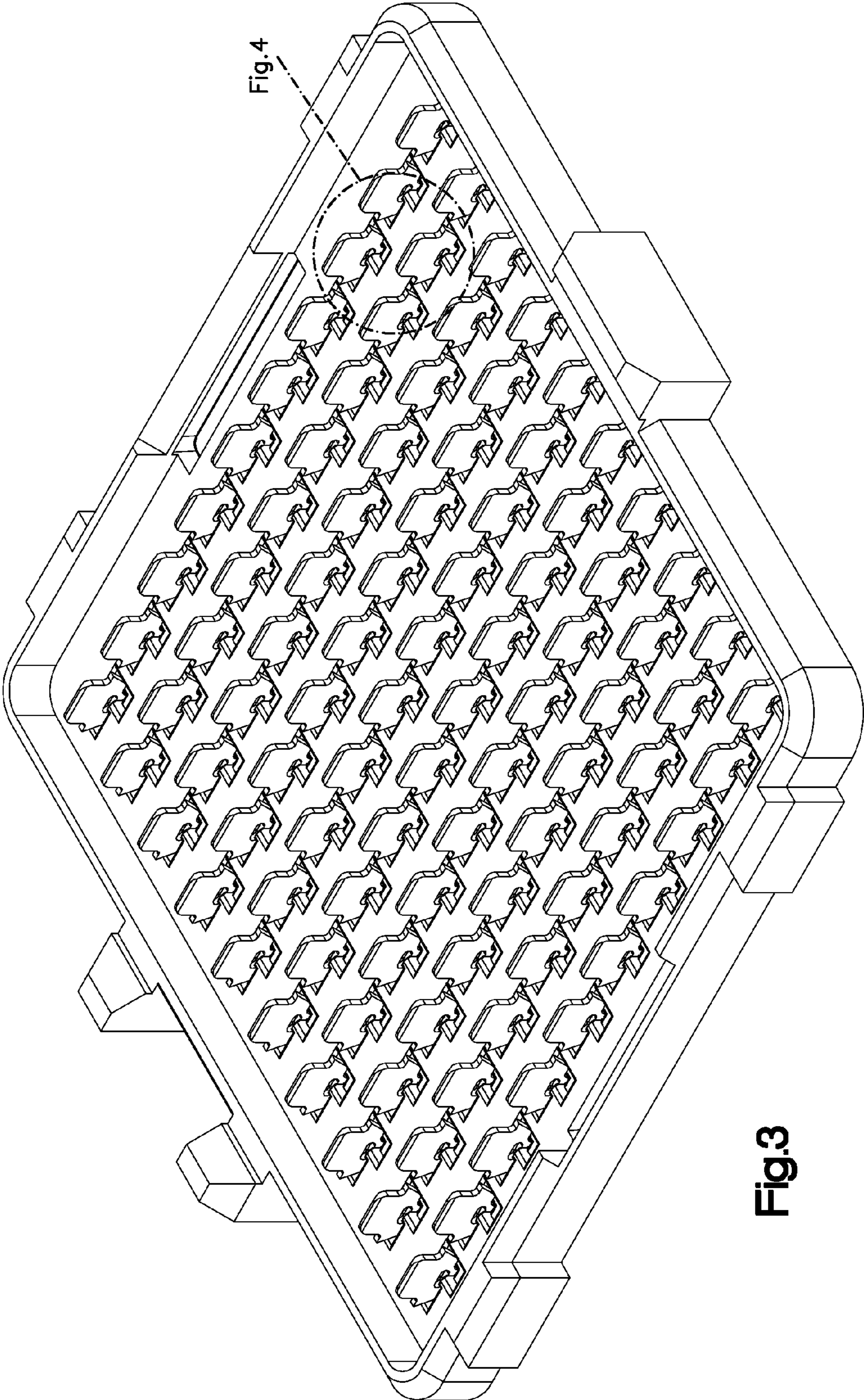


Fig.3



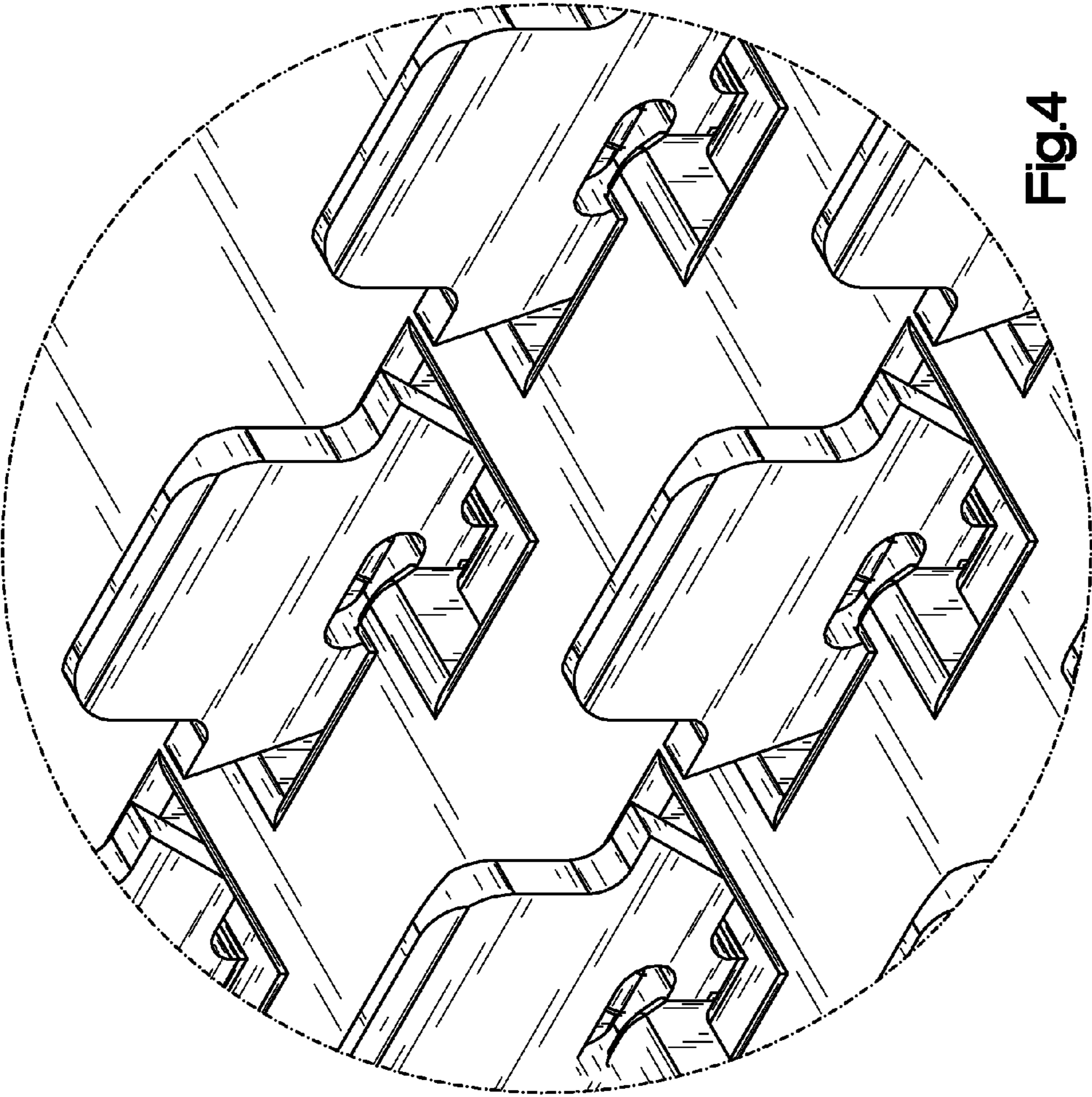


Fig.4



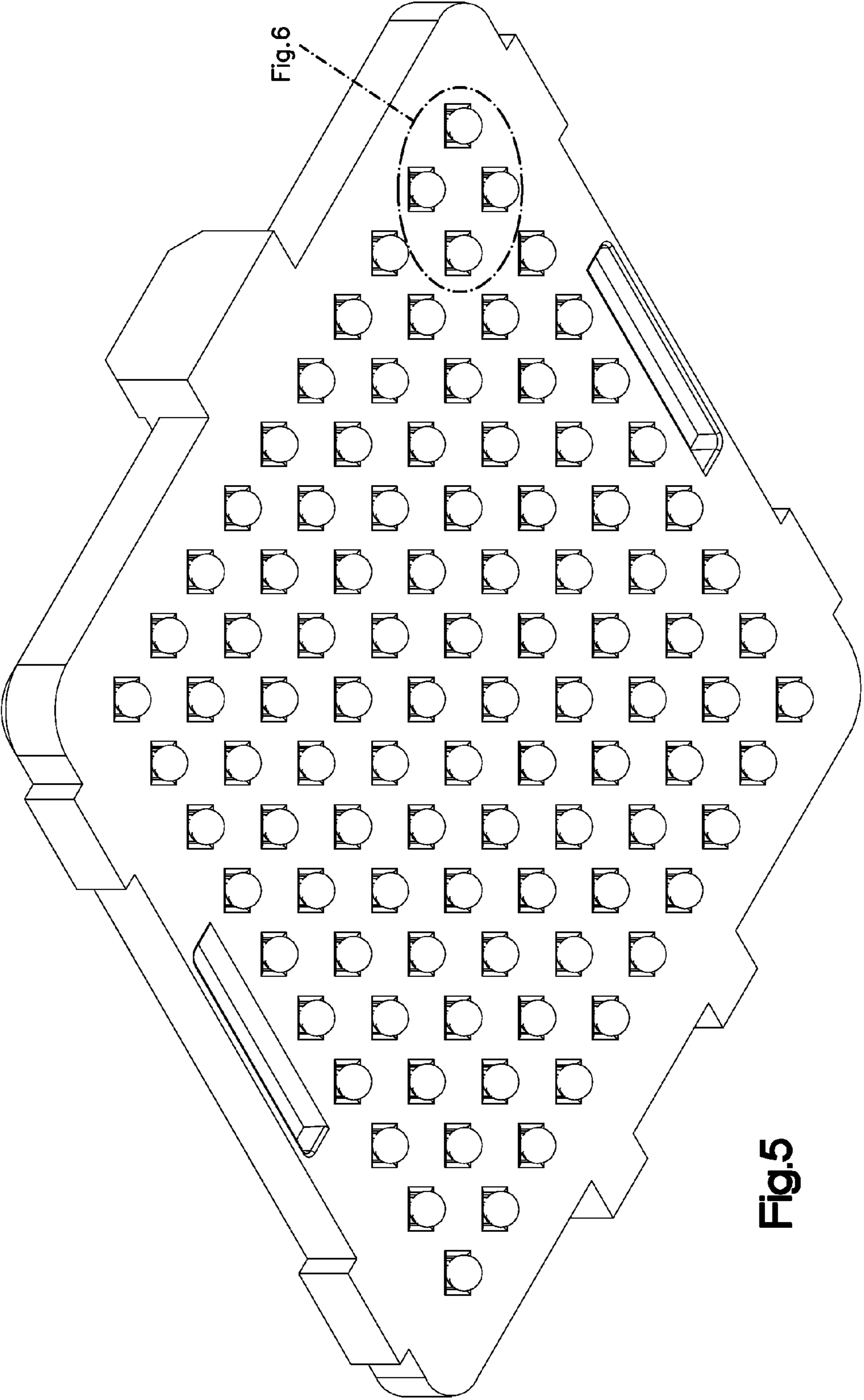


Fig.6

Fig.5



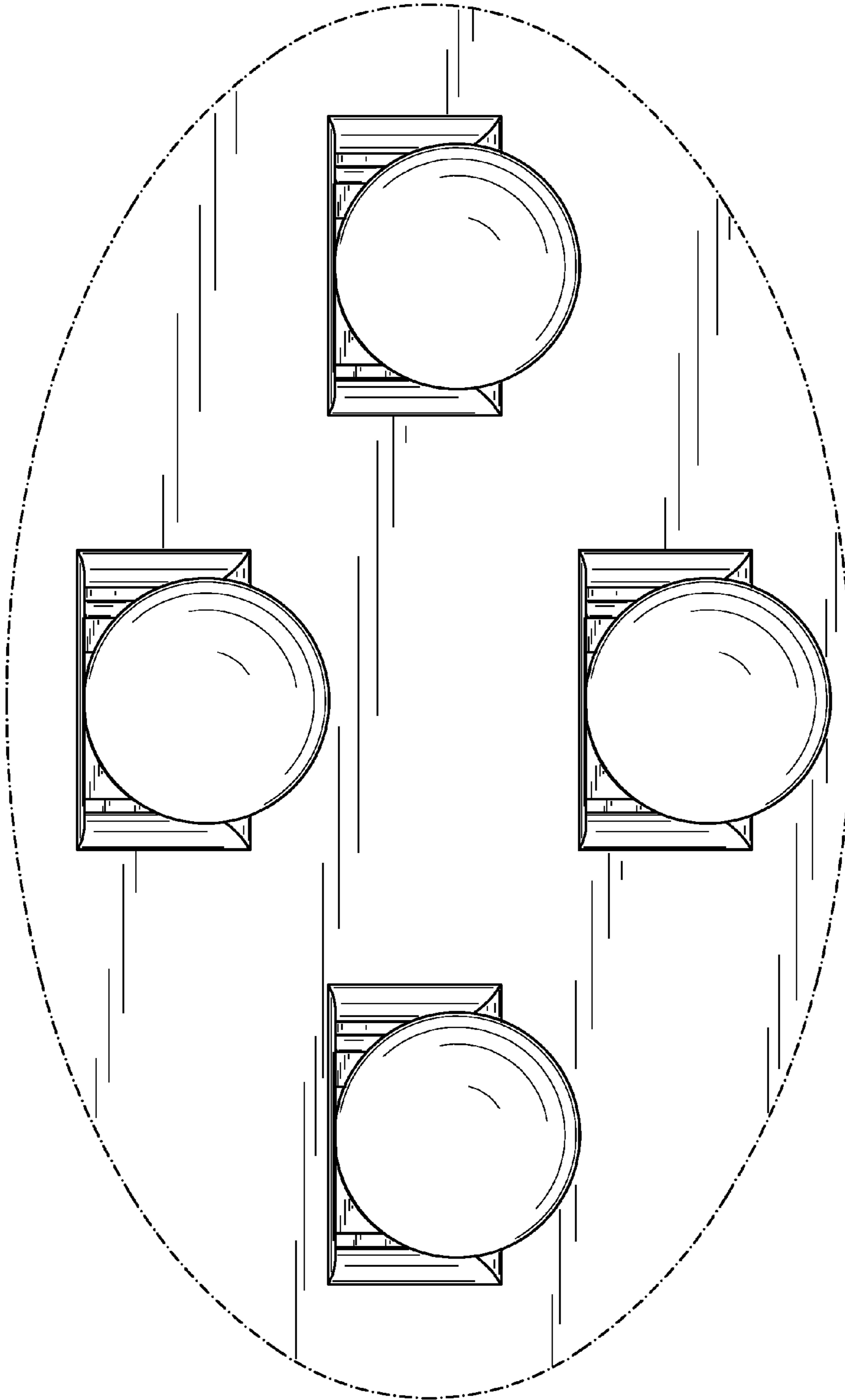
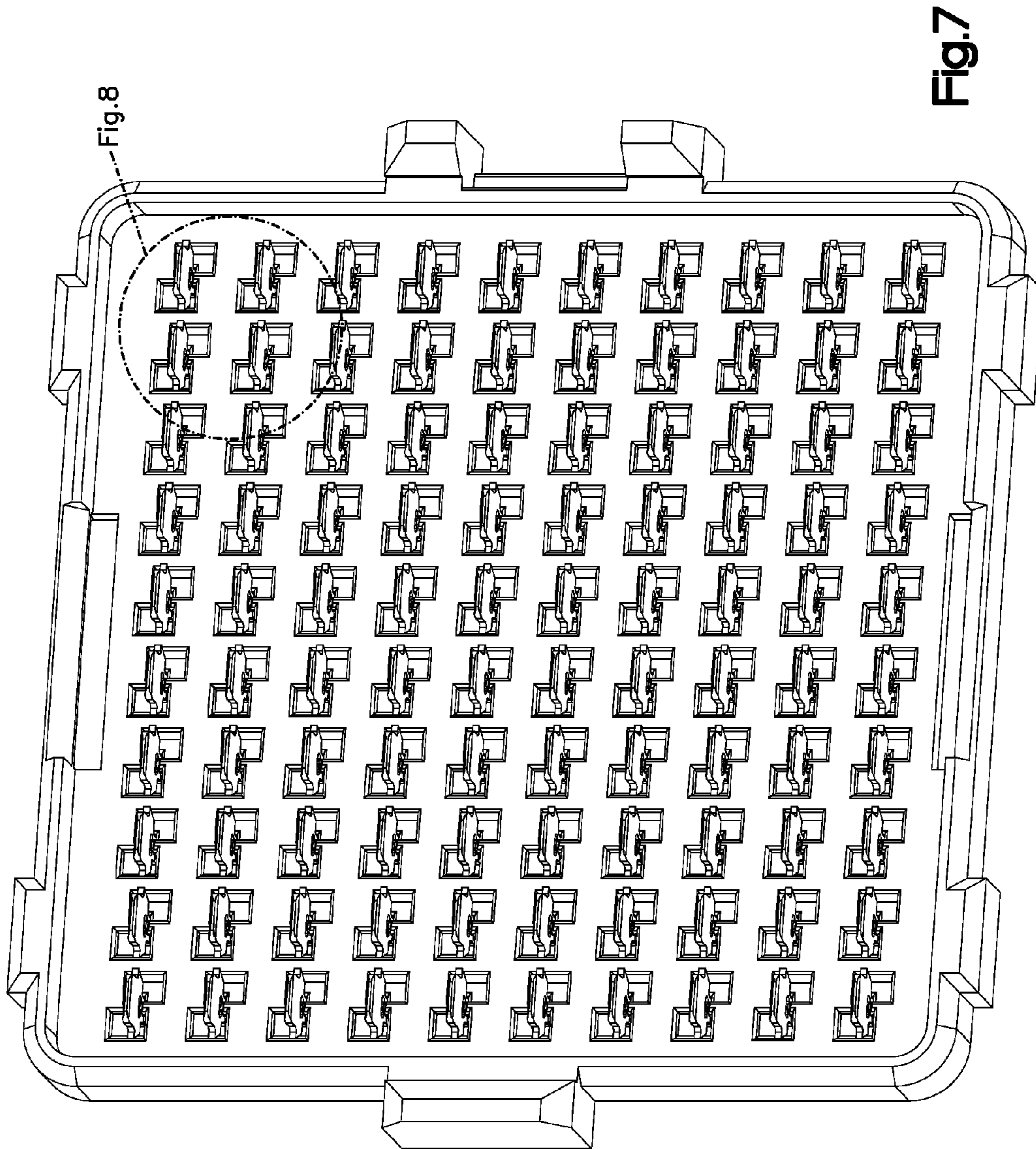


Fig.6







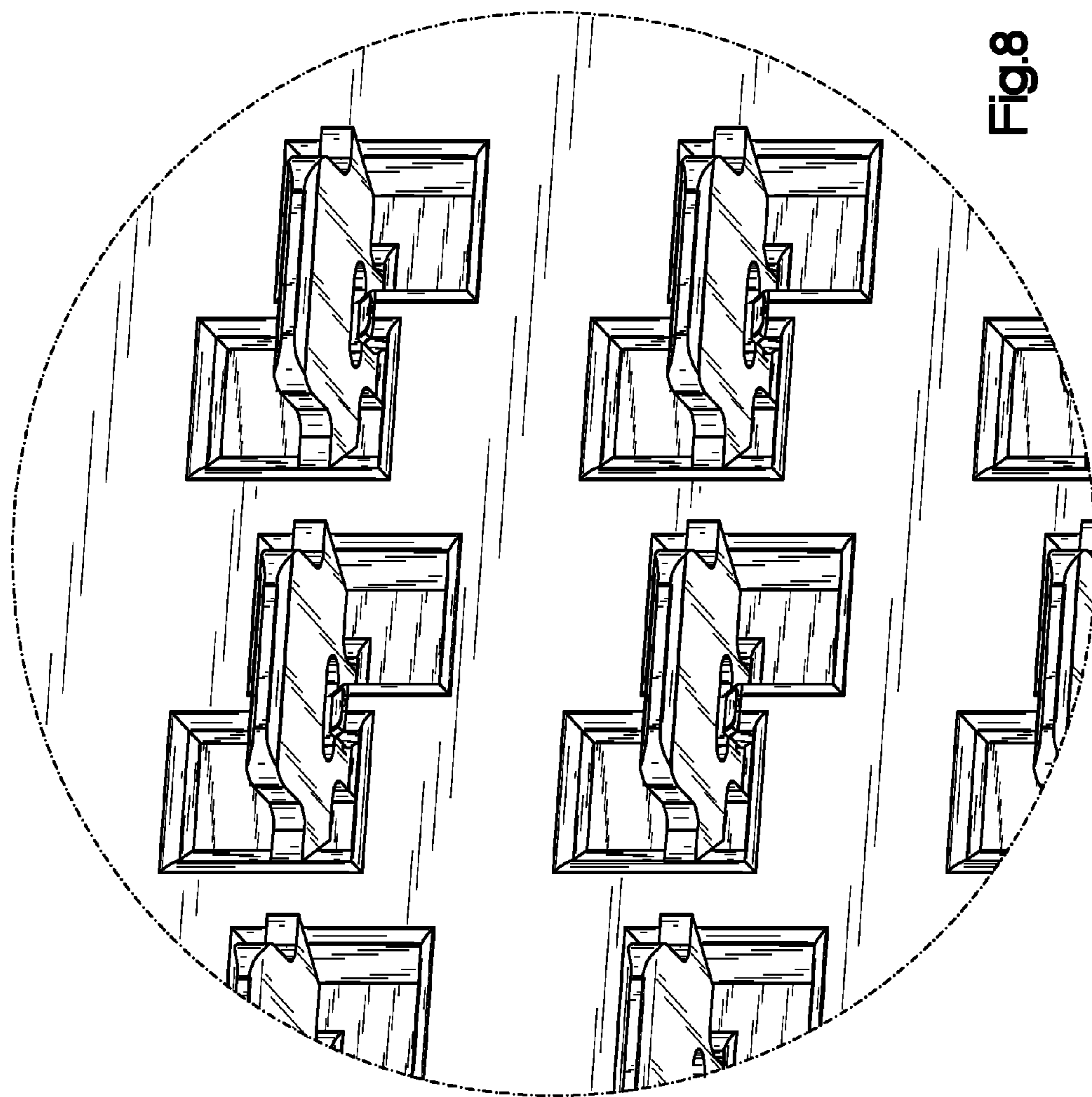
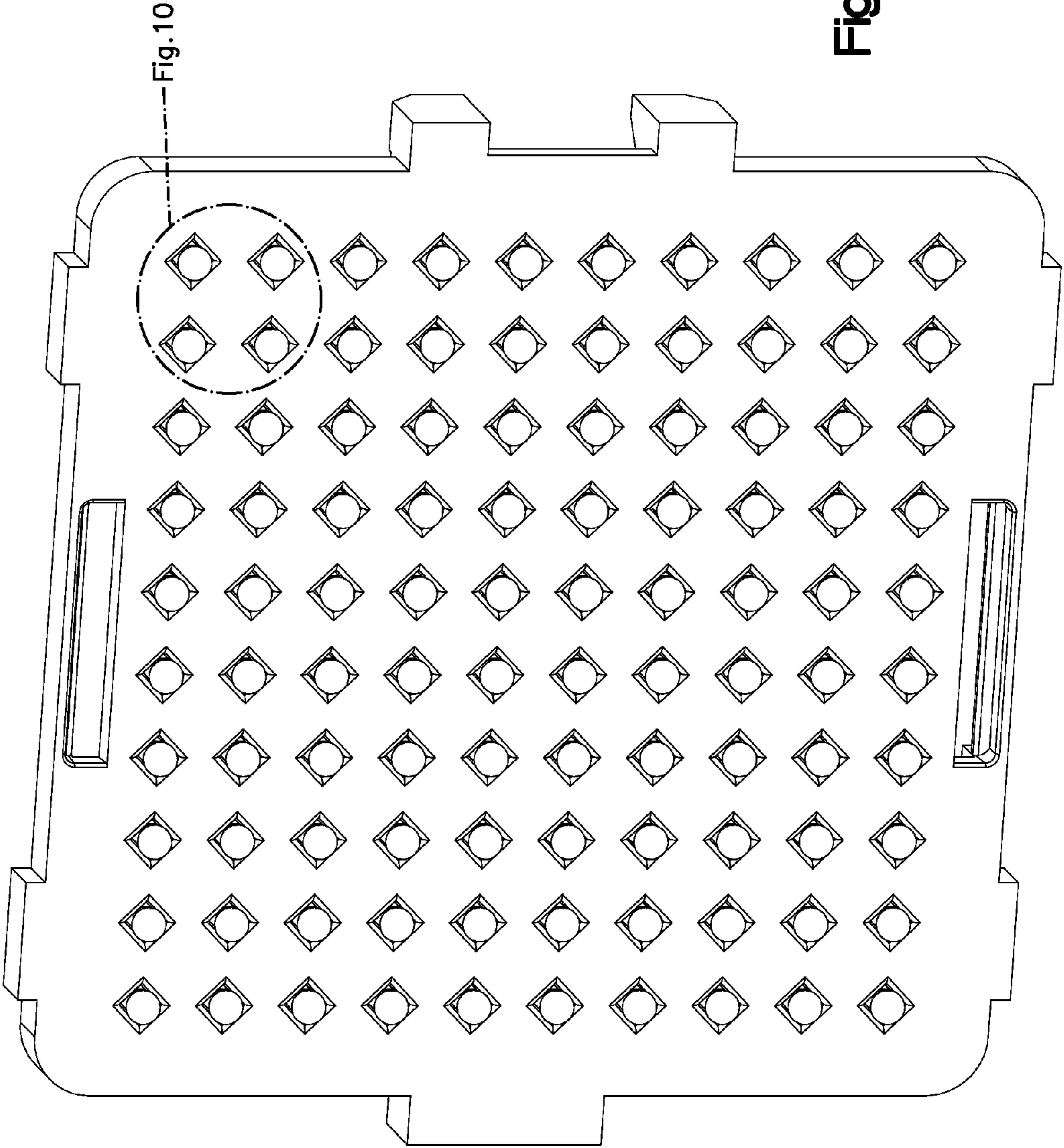


Fig.8



Fig.9





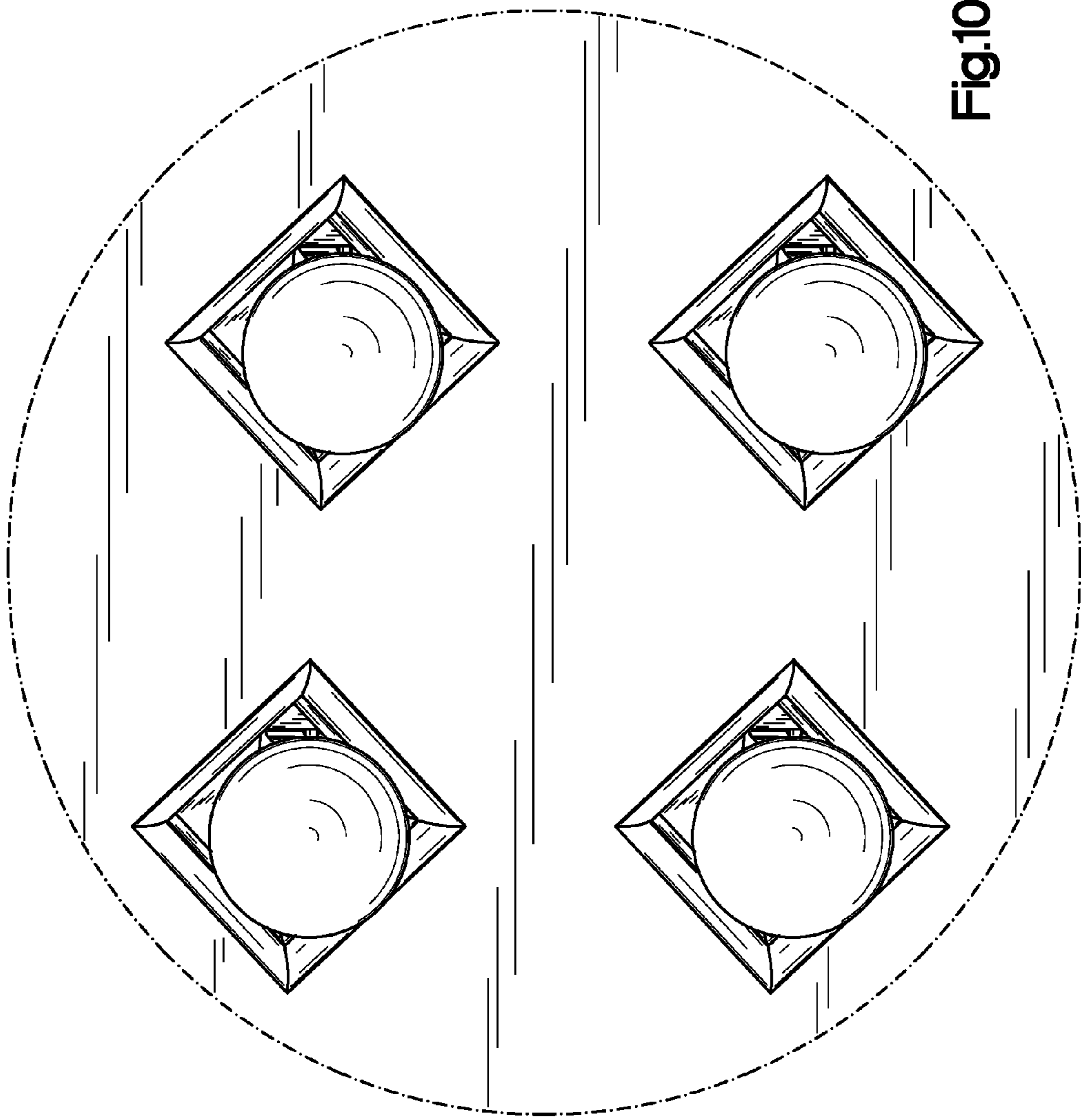


Fig.10

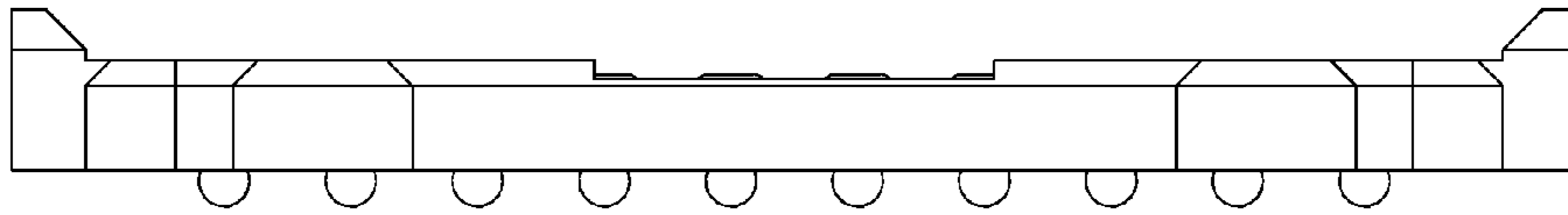


Fig.11

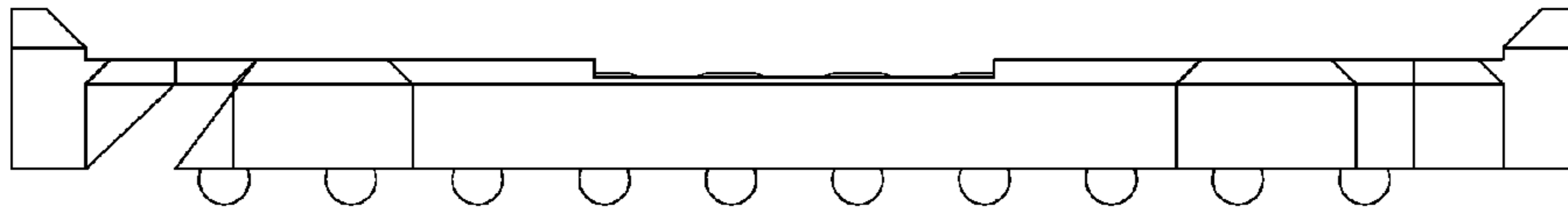


Fig.12

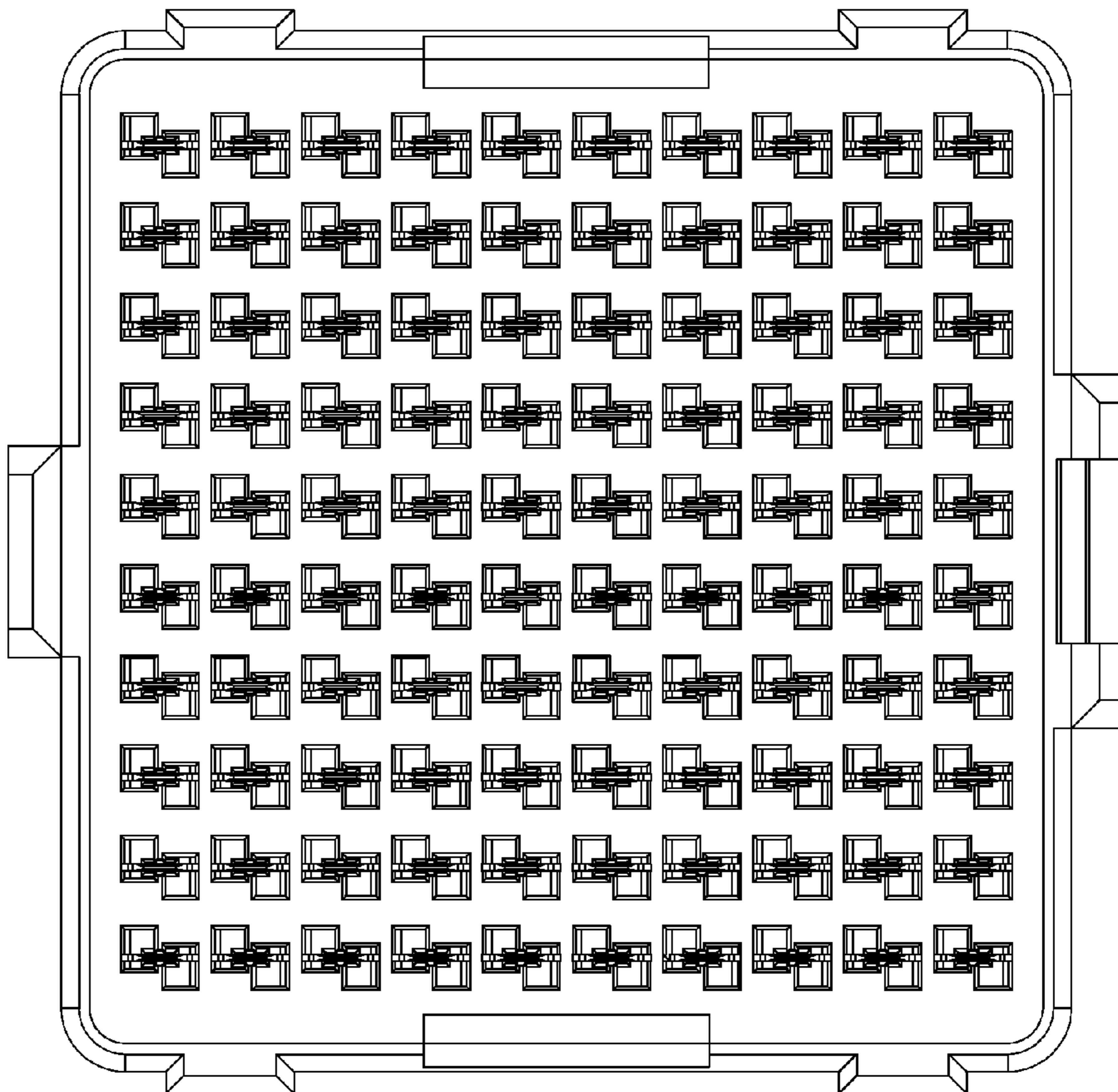


Fig.13



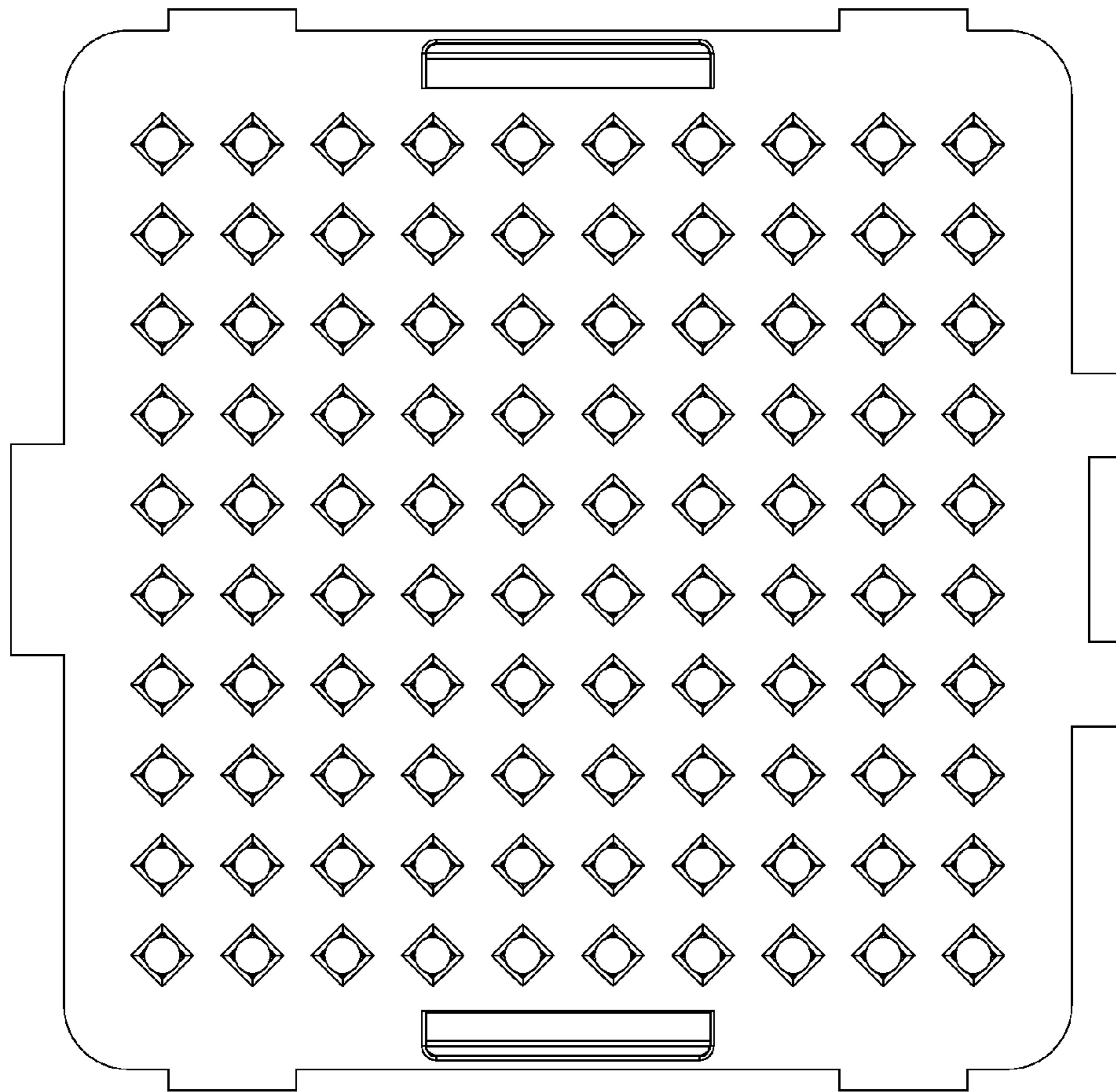


Fig.14

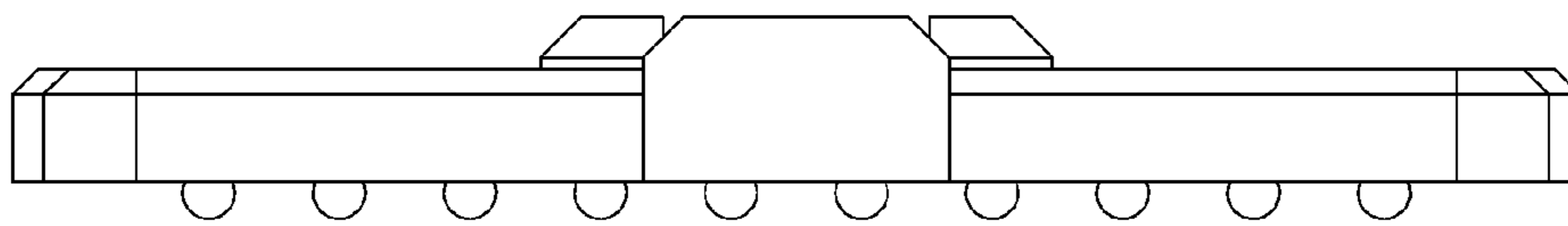


Fig.15

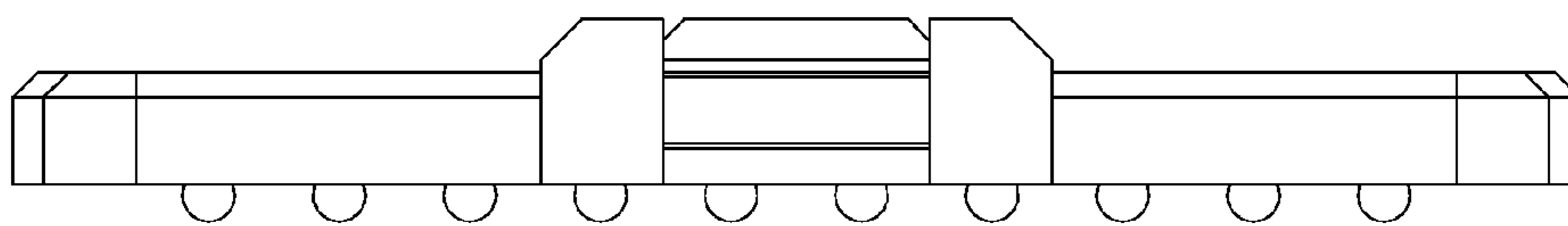


Fig.16